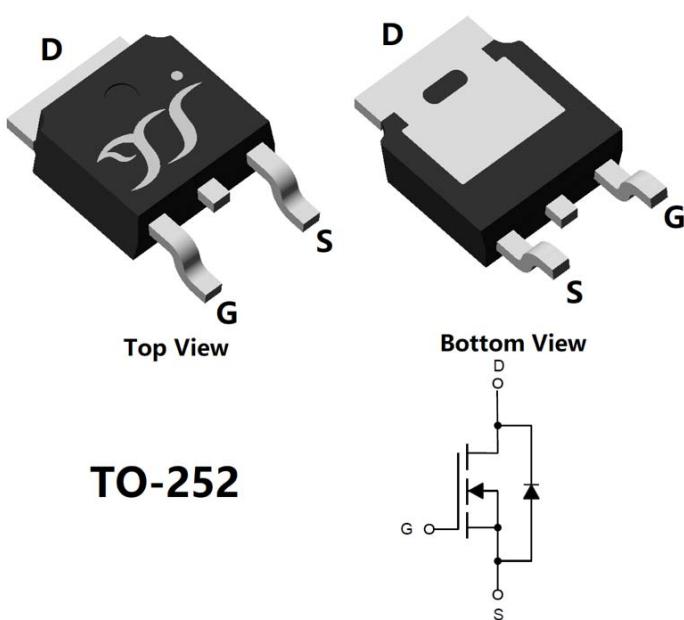


N-Channel Enhancement Mode Field Effect Transistor



Product Summary

- V_{DS} 40 V
- I_D 60 A
- $R_{DS(ON)}$ (at $V_{GS} = 10V$) <7.0 mohm
- $R_{DS(ON)}$ (at $V_{GS} = 4.5V$) <9.5 mohm
- 100% EAS Tested
- 100% ∇V_{DS} Tested
- ESD Level(HBM) Class 1C

General Description

- Trench Power LV MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low $R_{DS(ON)}$
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- High current load applications
- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

■ Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		V_{DS}	40	V
Gate-source Voltage		V_{GS}	± 20	V
Drain Current	$T_c=25^\circ\text{C}$	I_D	60	A
	$T_c=100^\circ\text{C}$		38	
Pulsed Drain Current ^A		I_{DM}	200	A
Total Power Dissipation	$T_c=25^\circ\text{C}$	P_D	44	W
	$T_c=100^\circ\text{C}$		17	
Single Pulse Avalanche Energy ^B		E_{AS}	110	mJ
Thermal Resistance Junction-to-Case ^C		$R_{\theta JC}$	2.8	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature Range		T_J, T_{STG}	-55~+150	$^\circ\text{C}$

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJD60N04A	F1/F2	YJD60N04A	2500	/	25000	13" reel



YJD60N04A

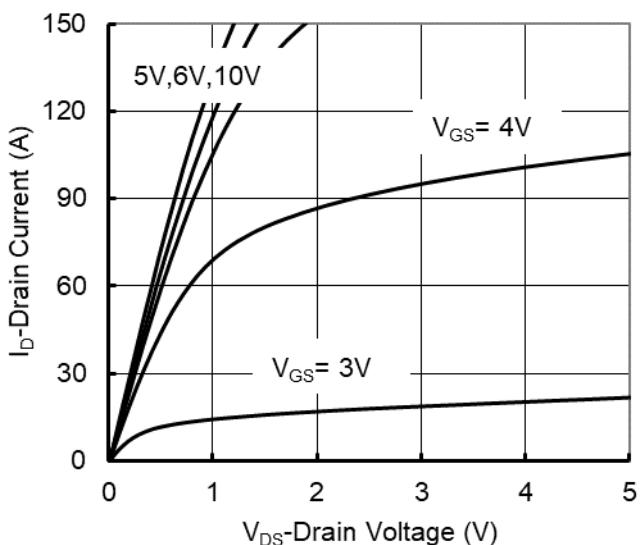
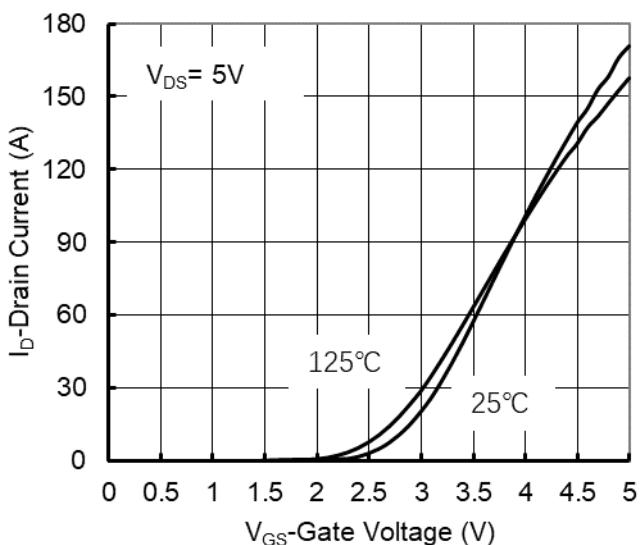
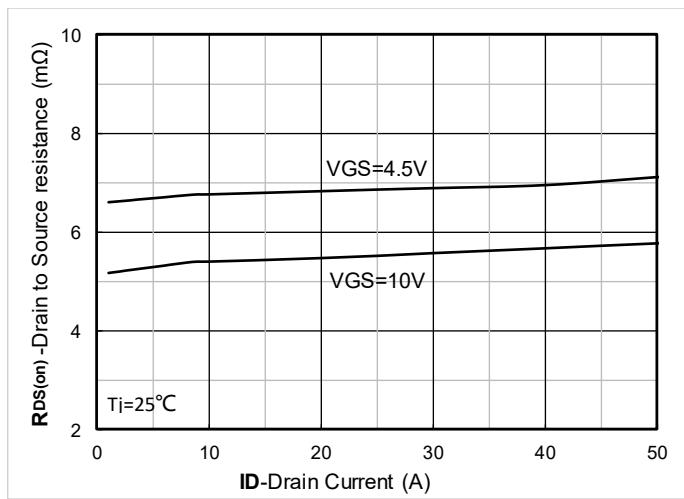
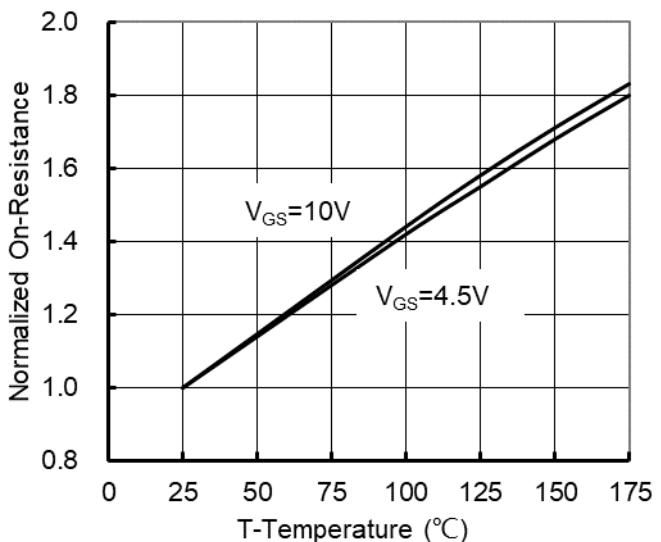
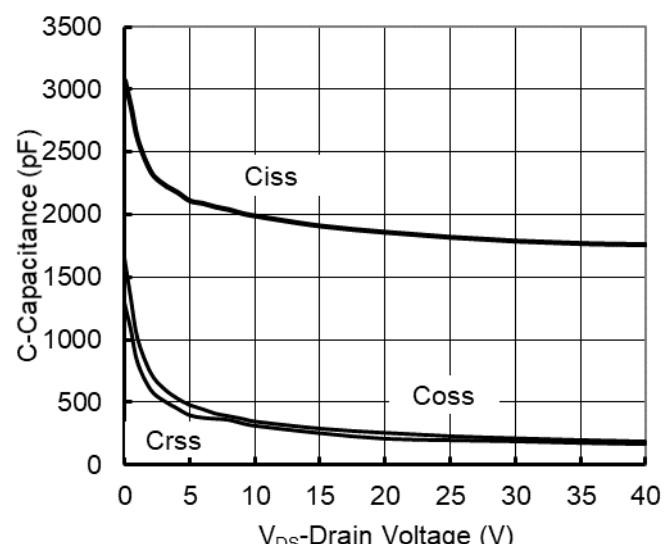
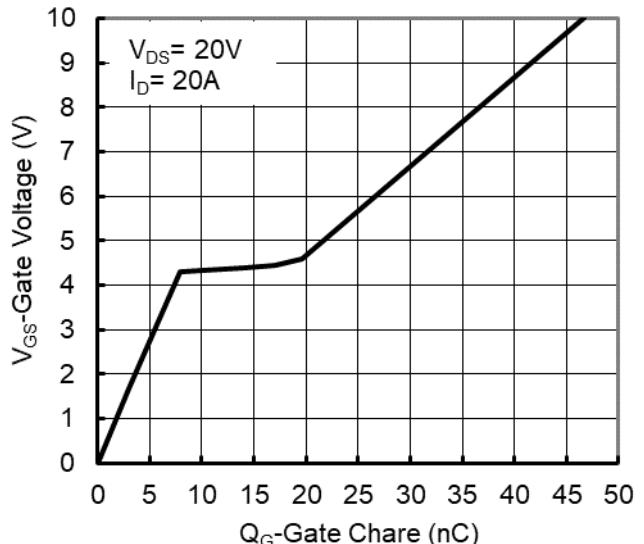
■ Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions		Min	Typ	Max	Units
Static Parameter							
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$		40			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}}=40\text{V}, V_{\text{GS}}=0\text{V}$	$T_J=25^\circ\text{C}$			1	μA
			$T_J=150^\circ\text{C}$			100	
Gate-Body Leakage Current	I_{GSS}	$V_{\text{GS}}= \pm 20\text{V}, V_{\text{DS}}=0\text{V}$				± 100	nA
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}= 250\mu\text{A}$		1.0	1.5	2.5	V
Static Drain-Source On-Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}= 10\text{V}, I_{\text{D}}=20\text{A}$			5.4	7	$\text{m}\Omega$
		$V_{\text{GS}}= 4.5\text{V}, I_{\text{D}}=10\text{A}$			6.8	9.5	
Diode Forward Voltage	V_{SD}	$I_{\text{S}}=20\text{A}, V_{\text{GS}}=0\text{V}$			0.8	1.2	V
Maximum Body-Diode Continuous Current	I_{S}					60	A
Dynamic Parameters							
Input Capacitance	C_{iss}	$V_{\text{DS}}=20\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$			1860		pF
Output Capacitance	C_{oss}				256		
Reverse Transfer Capacitance	C_{rss}				205		
Switching Parameters							
Total Gate Charge	Q_{g}	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=20\text{V}, I_{\text{D}}=20\text{A}$			46.7		nC
Gate-Source Charge	Q_{gs}				8		
Gate-Drain Charge	Q_{gd}				11.6		
Reverse Recovery Charge	Q_{rr}	$I_{\text{F}}=20\text{A}, di/dt=100\text{A/us}$			2.3		ns
Reverse Recovery Time	t_{rr}				15		
Turn-on Delay Time	$t_{\text{D(on)}}$				10		
Turn-on Rise Time	t_{r}	$V_{\text{GS}}=10\text{V}, V_{\text{DD}}=20\text{V}, I_{\text{D}}=2\text{A}, R_{\text{L}}=1\Omega, R_{\text{GEN}}=3\Omega$			21		ns
Turn-off Delay Time	$t_{\text{D(off)}}$				36		
Turn-off fall Time	t_{f}				25		

A. Pulse Test: Pulse Width $\leqslant 300\text{us}$, Duty cycle $\leqslant 2\%$.

B. $T_J=25^\circ\text{C}$, $V_{\text{DD}}=38\text{V}$, $V_G=10\text{V}$, $L=0.5\text{mH}$, $I_{\text{AS}}=21\text{A}$

C. R_{\thetaJA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{\thetaJC} is guaranteed by design, while R_{\thetaJA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.

**■ Typical Performance Characteristics****Figure 1. Output Characteristics****Figure 2. Transfer Characteristics****Figure 3. On-Resistance vs. Drain Current and Gate Voltage****Figure 4. On-Resistance vs. Junction Temperature****Figure 5. Capacitance Characteristics****Figure 6. Gate Charge**

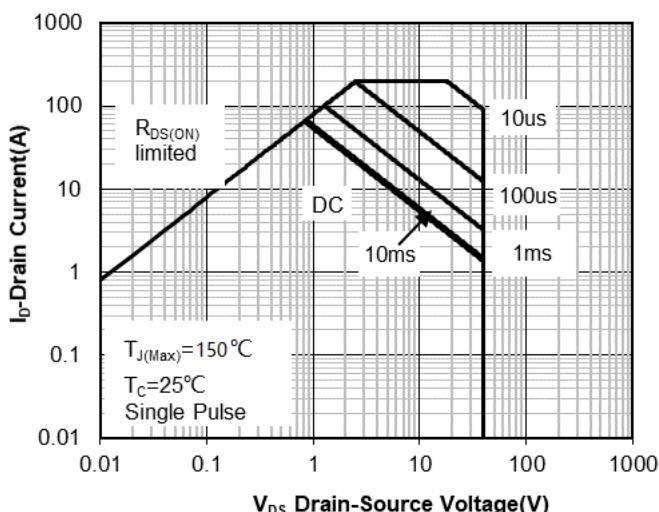


Figure 7. Safe Operation Area

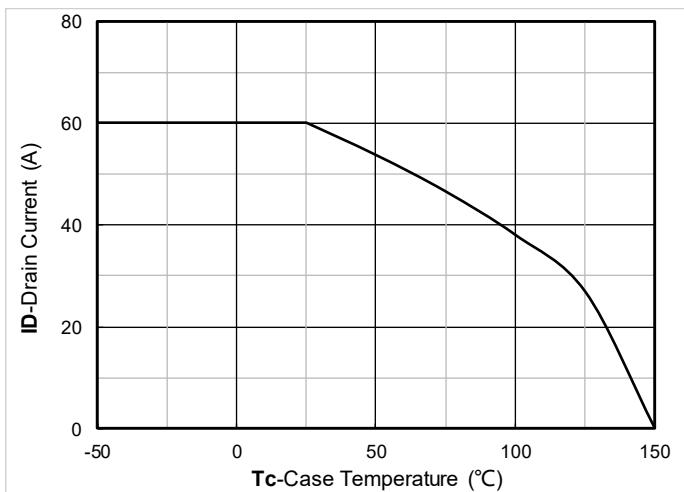


Figure 8. Maximum Continuous Drain Current vs Case Temperature

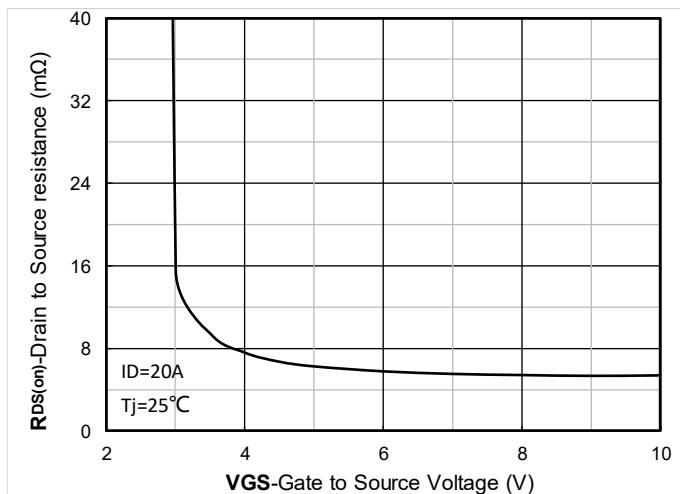


Figure 9. On-Resistance vs Gate to Source Voltage

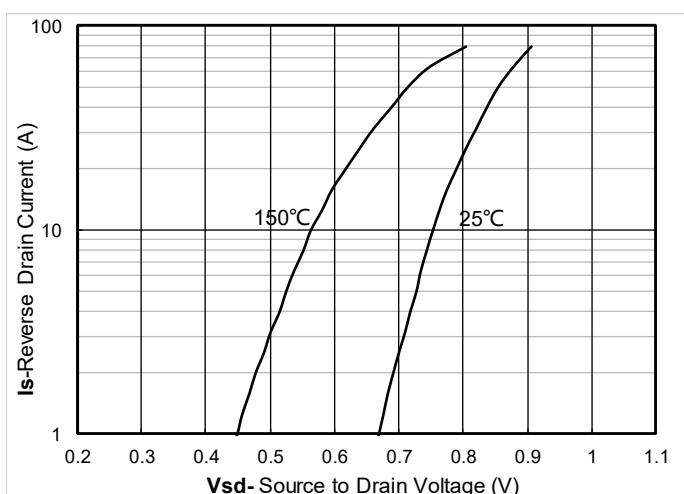


Figure 10. Forward characteristics of reverse diode

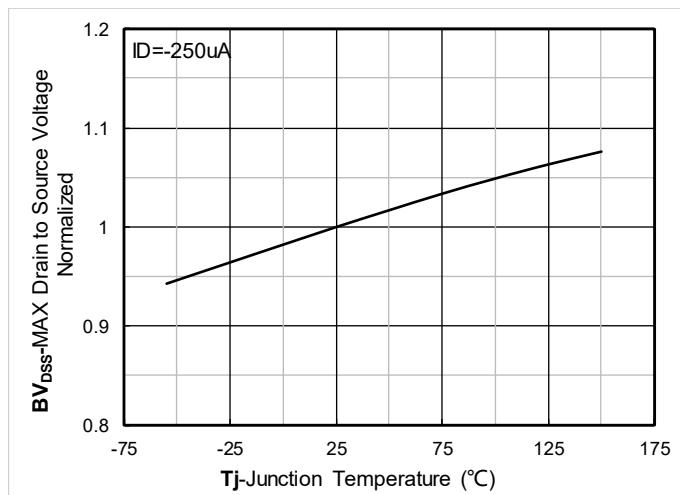


Figure 11. Normalized breakdown voltage

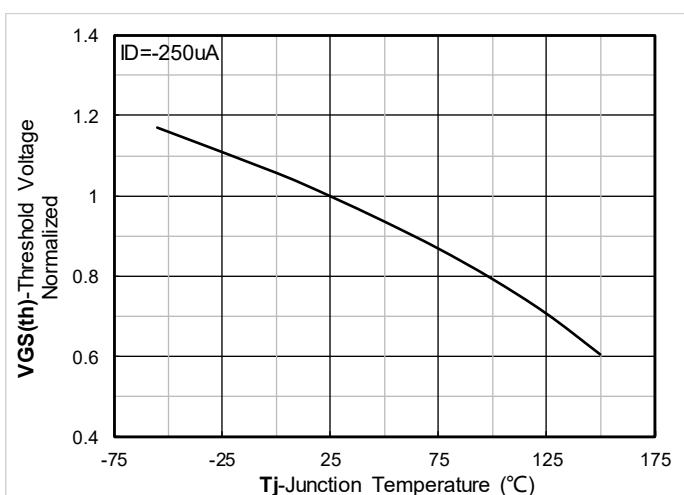


Figure 12. Normalized Threshold voltage



YJD60N04A

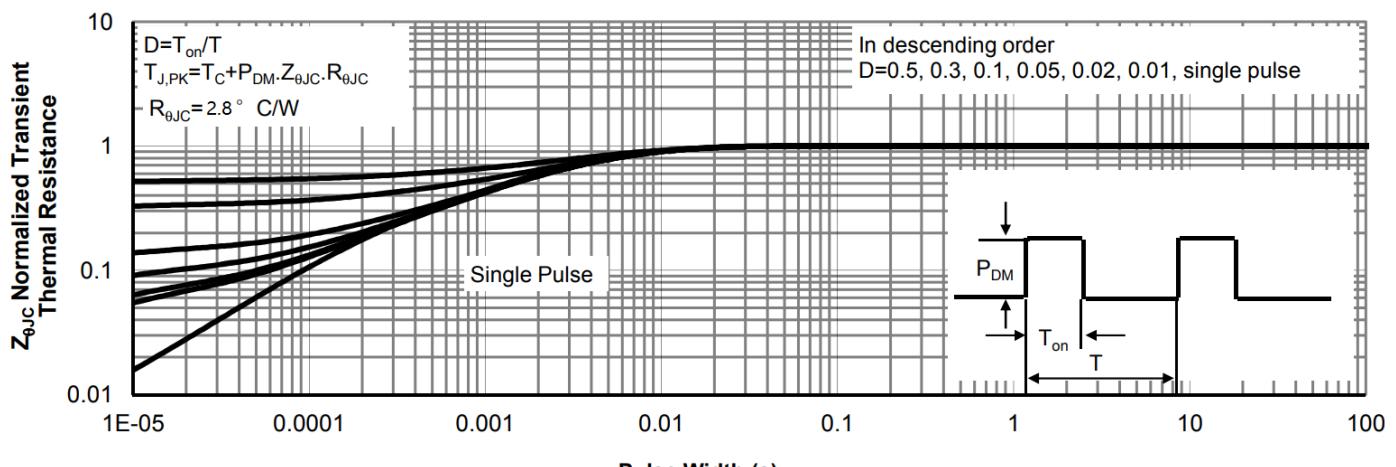
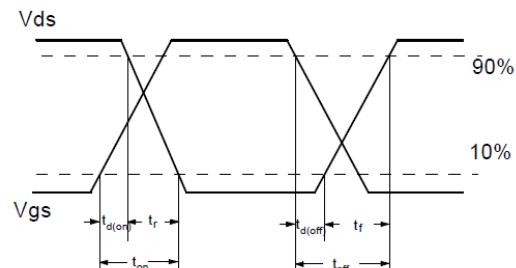
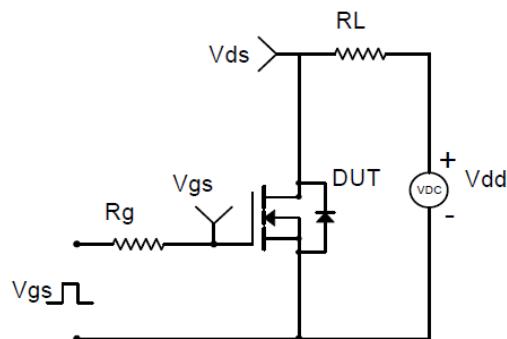
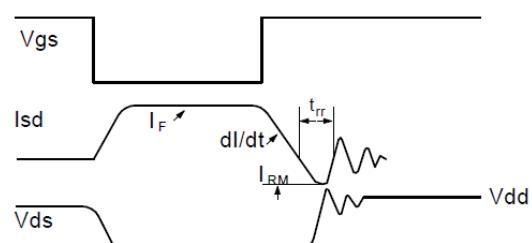
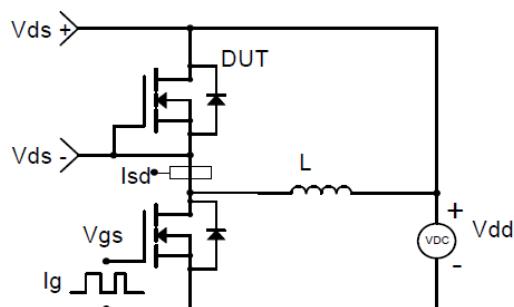


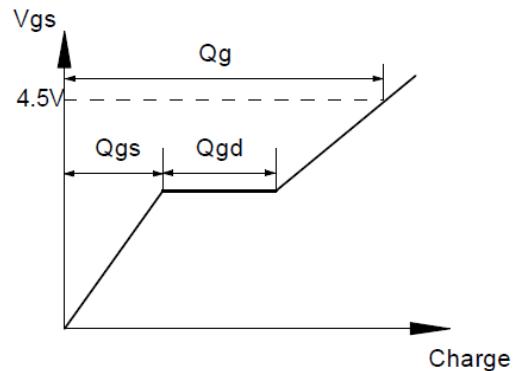
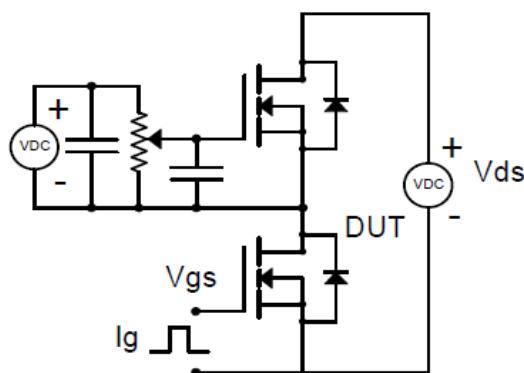
Figure 13. Normalized Maximum Transient Thermal Impedance



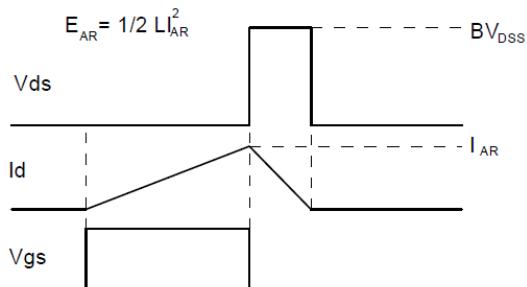
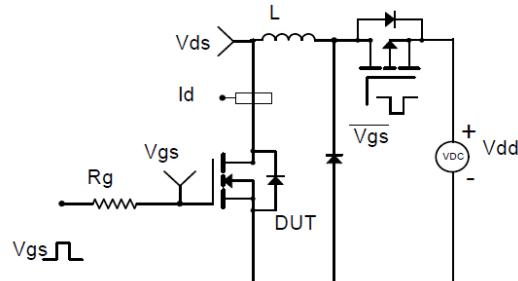
Resistive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



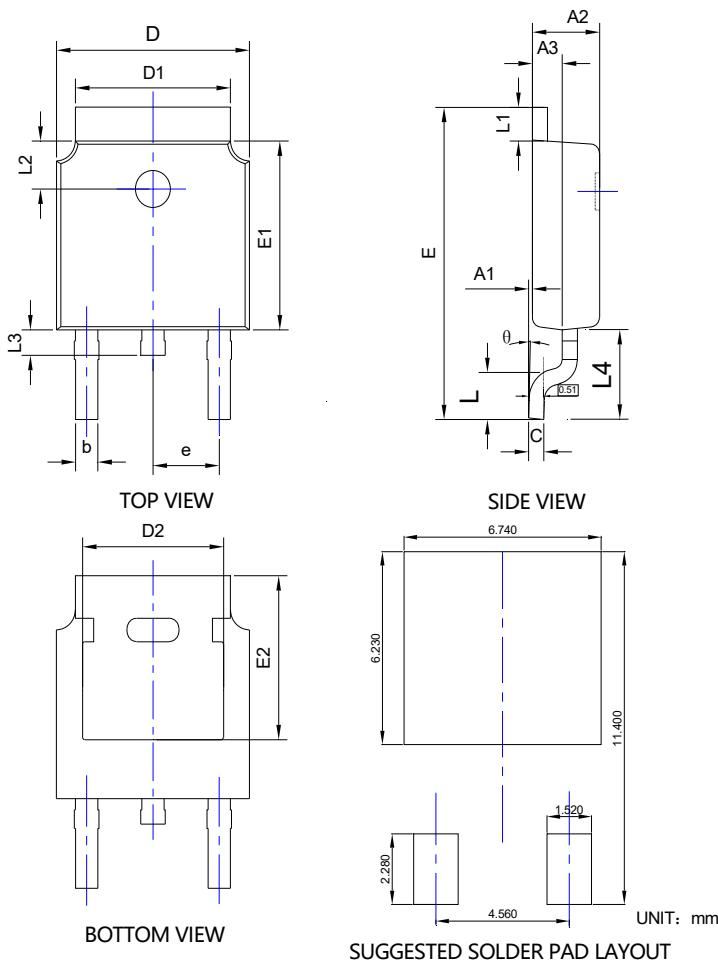
Gate Charge Test Circuit & Waveform



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



■ TO-252-B Package information



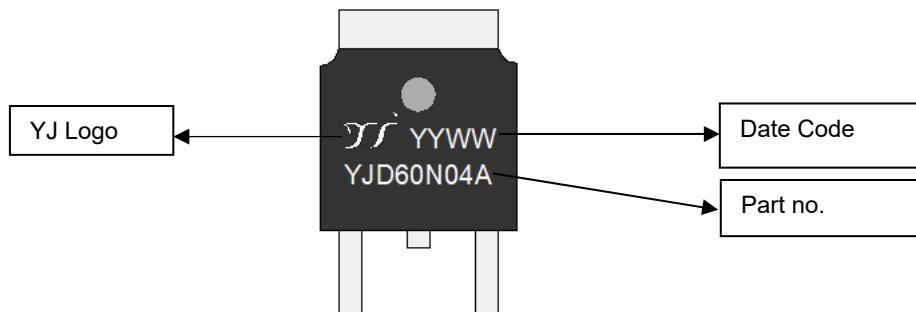
SYMBOL	DIMENSIONS			Millimeter		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A1	0.000	—	0.008	0.000	—	0.200
A2	0.087	0.091	0.094	2.200	2.300	2.400
A3	0.035	0.039	0.043	0.900	1.000	1.100
b	0.026	0.030	0.034	0.660	0.760	0.860
c	0.018	0.020	0.023	0.460	0.520	0.580
D	0.256	0.260	0.264	6.500	6.600	6.700
D1	0.203	0.209	0.215	5.150	5.300	5.450
D2	0.181	0.189	0.195	4.600	4.800	4.950
E	0.390	0.398	0.406	9.900	10.100	10.300
E1	0.236	0.240	0.244	6.000	6.100	6.200
E2	0.203	0.209	0.215	5.150	5.300	5.450
e	0.090BSC			2.286BSC		
L	0.049	0.059	0.069	1.250	1.500	1.750
L1	0.035	—	0.050	0.900	—	1.270
L2	0.055	—	0.075	1.400	—	1.900
L3	0.024	0.031	0.039	0.600	0.800	1.000
L4	0.114REF			2.900REF		
θ	0°	—	10°	0°	—	10°

NOTE:

- 1.PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
- 2.TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.
- 3.THE PAD LAYOUT IS FOR REFERENCE PURPOSES ONLY.



■ Marking Information



Note:

1. All marking is at middle of the product body
2. All marking is in laser printing
3. YJD60N04A is part no., YYWW is date code, "YY" is year, "WW" is week
4. Body color: Black



Disclaimer

The information presented in this document is for reference only. Yangzhou Yangjie Electronic Technology Co., Ltd. reserves the right to make changes without notice for the specification of the products displayed herein to improve reliability, function or design or otherwise.

The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Yangjie or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use of sale.

This publication supersedes & replaces all information previously supplied. For additional information, please visit our website <http://www.21yangjie.com>, or consult your nearest Yangjie's sales office for further assistance.